PCA8561 Automotive 18 × 4 LCD segment driver Rev. 4 – 27 March 2015

Product data sheet

1. General description

PCA8561 is an ultra low-power LCD segment driver with 4 backplane- and 18 segment-driver outputs, with either an I²C- or an SPI-bus interface. It comprises an internal oscillator, bias generation, instruction decoding, and display controller.

For a selection of NXP LCD segment drivers, see <u>Table 24 on page 45</u>.

2. Features and benefits

- AEC-Q100 grade 2 (up to 105 °C) compliant for automotive applications
- Single chip LCD controller and driver
- Selectable backplane drive configuration: static, 2, 3, or 4 backplane multiplexing
- Selectable display bias configuration: static, ¹/₂, or ¹/₃
- Internal LCD bias generation with buffers
- 18 segment drives:
 - Up to 9 7-segment numeric characters
 - Up to 4 14-segment alphanumeric characters
 - Any graphics of up to 72 segments/elements
- Auto-incrementing display data and instruction loading
- Versatile blinking modes
- Independent supplies of V_{LCD} and V_{DD}
- Power supply ranges:
 - 1.8 V to 5.5 V for V_{LCD}
 - 1.8 V to 5.5 V for V_{DD}
- Ultra low-power consumption
- 400 kHz I²C-bus interface (PCA8561AHN)
- 5 MHz SPI-bus interface (PCA8561BHN)
- Internally generated or externally supplied clock signal
- Tiny package: HVQFN32, 5 mm × 5 mm

3. Applications

- Small displays integrated
 - in a car instrument cluster
 - in a control knob
- Battery operated applications
- Healthcare devices



4. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | |
|-------------|---------|--|----------|--|--|--|
| | Name | Name Description | | | | |
| PCA8561AHN | HVQFN32 | plastic thermal enhanced very thin quad flat package; no leads;32 terminals; body 5 x 5 \times 0.85 mm | SOT617-3 | | | |
| PCA8561BHN | HVQFN32 | plastic thermal enhanced very thin quad flat package; no leads;32 terminals; body 5 x 5×0.85 mm | SOT617-3 | | | |

4.1 Ordering options

Table 2. Ordering options

| Product type number | Orderable part number | Sales item (12NC) | Interface type | Delivery form | IC revision |
|------------------------|--------------------------|----------------------|----------------------|-------------------------------------|----------------|
| PCA8561AHN/A | PCA8561AHN/AY | 935304072518 | I ² C-bus | tape and reel, 13 inch, dry pack | 1 |
| PCA8561BHN/A | PCA8561BHN/AY | 935305329518 | SPI-bus | tape and reel, 13 inch, dry pack | 1 |

5. Marking

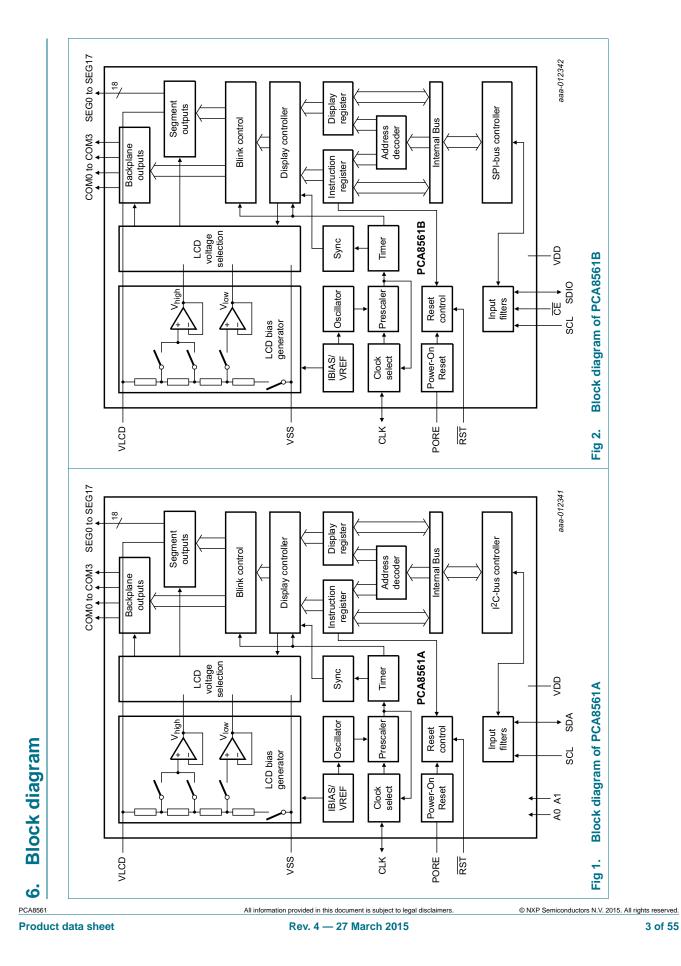
| Table 3. N | larking codes |
|------------|---------------|
|------------|---------------|

| Type number | Marking code |
|--------------|--------------|
| PCA8561AHN/A | 8561A |
| PCA8561BHN/A | 8561B |

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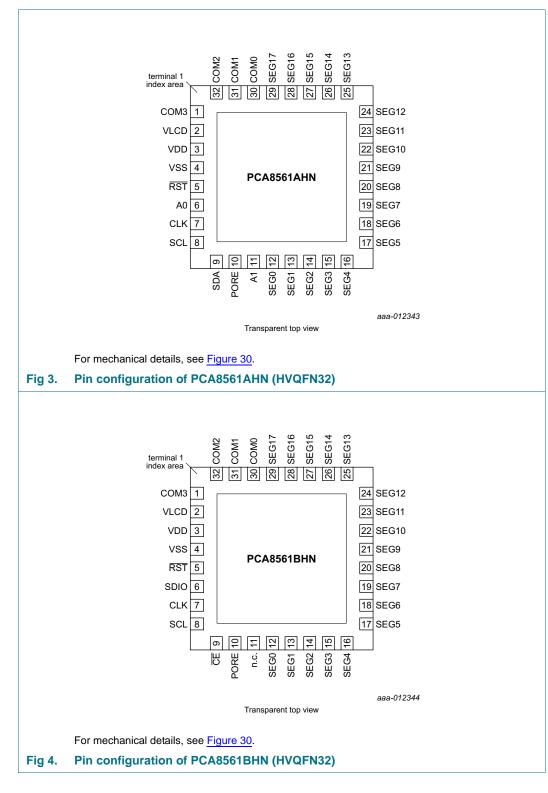
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7. Pinning information

7.1 Pinning



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7.2 Pin description

Table 4.Pin description

Input or input/output pins must always be at a defined level (V_{SS} or V_{DD}) unless otherwise specified.

| Pin | Symbol | | Туре | Description |
|----------|--------------------------------------|-------------------------|--------------|---|
| 1 | COM3 output | | output | LCD backplane output |
| 2 | VLCD | | supply | LCD supply voltage |
| 3 | VDD | | supply | supply voltage |
| 4 | VSS[1] | | supply | ground supply |
| 5 | RST | | input | reset input, active LOW |
| 7 | CLK | | input/output | internal oscillator output, external oscillator input |
| | | | | must be left open if unused |
| 8 | SCL | | input | serial clock input |
| 10 | PORE ^[2] | | input | Power-On Reset (POR) enable |
| | | | | connect to V_{DD} for enabling POR |
| | | | | - connect to V_{SS} (or leave open) for disabling POR |
| 12 to 29 | SEG0 to SEG17 | | output | LCD segment outputs |
| 30 to 32 | COM0 to COM2 | | output | LCD backplane outputs |
| Pin layo | ut depending or | n product and b | us type | |
| | PCA8561AHN (I ² C-bus) | PCA8561BHN (SPI-bus) | | |
| 6 | A0[2] | - | input | hardware device address selection; |
| | | | | connect to V_{SS} (or leave open) for logic 0 |
| | | | | connect to V_{DD} for logic 1 |
| | - | SDIO | input/output | serial data input/output |
| 9 | SDA | - | output | serial data output |
| | - | CE | input | chip enable input, active LOW |
| 11 | A1 ^[2] | - | input | hardware device address selection; |
| | | | | connect to V_{SS} (or leave open) for logic 0 |
| | | | | connect to V_{DD} for logic 1 |
| | - | n.c. | - | not connected |

[1] The die paddle (exposed pad) is connected to V_{SS} and should be electrically isolated.

[2] A series resistance between V_{DD} and the pin must not exceed 1 k Ω to ensure proper functionality, see Section 16.3.

8. Functional description

8.1 Registers of the PCA8561

The registers of the PCA8561 are arranged in bytes with 8 bit, addressed by an address pointer. <u>Table 5</u> depicts the layout.

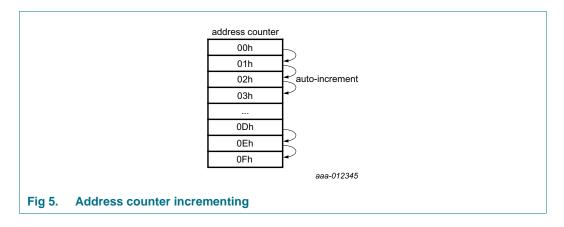
Table 5. Registers of the PCA8561

Bits labeled as 0 must always be written with logic 0; bits labeled as - are ignored by the device.

| Register name | Address | Bits | Bits | | | | | | | Reference |
|------------------|--------------------|---------|-------|-------|---------|---------|---------|-------|-------|-----------|
| | AP[4:0] | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| Command regis | ters | | | | | | | | | |
| Software_reset | 00h | SR[7:0] | .0] | | | | | | | |
| Device_ctrl | 01h | 0 | 0 | 0 | FF[2:0] | | | OSC | COE | Table 6 |
| Display_ctrl_1 | 02h | 0 | 0 | 0 | BOOST | MUX[1:0 |] | В | DE | Table 7 |
| Display_ctrl_2 | 03h | 0 | 0 | 0 | 0 | 0 | BL[1:0] | - | INV | Table 8 |
| Display data reg | jisters[<u>1]</u> | | | | | | | | | |
| COM0 | 04h | SEG7 | SEG6 | SEG5 | SEG4 | SEG3 | SEG2 | SEG1 | SEG0 | Table 10 |
| | 05h | SEG15 | SEG14 | SEG13 | SEG12 | SEG11 | SEG10 | SEG9 | SEG8 | |
| | 06h | - | - | - | - | - | - | SEG17 | SEG16 | |
| COM1 | 07h | SEG7 | SEG6 | SEG5 | SEG4 | SEG3 | SEG2 | SEG1 | SEG0 | _ |
| | 08h | SEG15 | SEG14 | SEG13 | SEG12 | SEG11 | SEG10 | SEG9 | SEG8 | |
| | 09h | - | - | - | - | - | - | SEG17 | SEG16 | |
| COM2 | 0Ah | SEG7 | SEG6 | SEG5 | SEG4 | SEG3 | SEG2 | SEG1 | SEG0 | _ |
| | 0Bh | SEG15 | SEG14 | SEG13 | SEG12 | SEG11 | SEG10 | SEG9 | SEG8 | |
| | 0Ch | - | - | - | - | - | - | SEG17 | SEG16 | |
| COM3 | 0Dh | SEG7 | SEG6 | SEG5 | SEG4 | SEG3 | SEG2 | SEG1 | SEG0 | |
| | 0Eh | SEG15 | SEG14 | SEG13 | SEG12 | SEG11 | SEG10 | SEG9 | SEG8 | |
| | 0Fh | - | - | - | - | - | - | SEG17 | SEG16 | |

[1] See <u>Table 10</u>.

For writing to the registers, send the address byte first, then write the data to the register (see <u>Section 11.1.4</u> and <u>Section 11.2.1</u>). The address byte works as an address pointer. For the succeeding registers, the address pointer is automatically incremented by 1 (see <u>Figure 5</u>) and all following data are written into these register addresses. After address 10h, the auto-incrementing will stop and data are ignored.



8.2 Command registers of the PCA8561

8.2.1 Command: Device_ctrl

The Device_ctrl command sets the device into a defined state. It should be executed before enabling the display (see bit DE in <u>Table 7</u>).

| Table 6. | e 6. Device_ctrl - device control command register (address 01h) bit description | | | | | |
|----------|--|--------|--|--|--|--|
| Bit | Symbol | Value | Description | | | |
| 7 to 5 | - | 000 | default value | | | |
| 4 to 2 | FF[2:0] | | frame frequency selection | | | |
| | | 000 | f _{fr} = 32 Hz | | | |
| | | 001[1] | f _{fr} = 64 Hz | | | |
| | | 010 | f _{fr} = 96 Hz | | | |
| | | 011 | f _{fr} = 128 Hz | | | |
| | | 100 | f _{fr} = 160 Hz | | | |
| | | 101 | f _{fr} = 192 Hz | | | |
| | | 110 | f _{fr} = 224 Hz | | | |
| | | 111 | f _{fr} = 256 Hz | | | |
| 1 | OSC | | internal oscillator control | | | |
| | | 0[1] | enabled | | | |
| | | 1 | disabled | | | |
| 0 | COE | | clock output enable | | | |
| | | 0[1] | clock signal not available on pin CLK; pin CLK is in 3-state | | | |
| | | 1 | clock signal available on pin CLK | | | |

[1] Default value.

8.2.1.1 Internal oscillator and clock output

Bit OSC enables or disables the internal oscillator. When the internal oscillator is used, bit COE allows making the clock signal available on pin CLK. If this is not intended, pin CLK should be left open. The design ensures that the duty cycle of the clock output is 50 : 50 (% HIGH-level time : % LOW-level time).

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In applications where an external clock has to be applied to the PCA8561, bit OSC must be set logic 1 and COE logic 0. In this case pin CLK becomes an input.

In power-down mode (see Section 8.3.1)

- if pin CLK is configured as an output, there is no signal on CLK
- if pin CLK is configured as an input, the signal on CLK can be removed.

Remark: A clock signal must always be supplied to the device if the display is enabled (see bit DE in <u>Table 7 on page 8</u>). Removing the clock may freeze the LCD in a DC state, which is not suitable for the liquid crystal.

8.2.2 Command: Display_ctrl_1

The Display_ctrl_1 command allows configuring the basic display set-up.

| Bit | Symbol | Value | Description |
|--------|----------|--|--|
| 7 to 5 | - | 000 | default value |
| 4 | BOOST | | large display mode support |
| | | 0[1] | standard power drive scheme |
| | | 1 | enhanced power drive scheme for higher display loads |
| 3 to 2 | MUX[1:0] | | multiplex drive mode selection |
| | | 00[1] | 1:4 multiplex drive mode; COM0 to COM3 (n _{MUX} = 4) |
| | 01 | 1:3 multiplex drive mode; COM0 to COM2 $(n_{MUX} = 3)$ | |
| | | 10 | 1:2 multiplex drive mode; COM0 and COM1 $(n_{MUX} = 2)$ |
| | | 11 | static drive mode; COM0 (n _{MUX} = 1) |
| 1 | B[2] | | bias mode selection |
| | | 0[1] | $\frac{1}{3}$ bias ($a_{bias} = 2$) |
| | | 1 | $\frac{1}{2}$ bias ($a_{bias} = 1$) |
| 0 | DE | | display enable ^[3] |
| | | 0[1] | display disabled; device is in power-down mode |
| | | 1 | display enabled; device is in power-on mode |

Table 7. Display_ctrl_1 - display control command 1 register (address 02h) bit description

- [1] Default value.
- [2] Not applicable for static drive mode.
- [3] See <u>Section 8.3.1</u>.

8.2.2.1 Enhanced power drive mode

By setting the BOOST bit to logic 1, the driving capability of the display signals is increased to cope with large displays with a higher effective capacitance. Setting this bit increases the current consumption on V_{LCD} .

8.2.2.2 Multiplex drive mode

MUX[1:0] sets the multiplex driving scheme and the associated backplane drive signals, which are active. For further details, see <u>Section 9.2 on page 15</u>.

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8.2.3 Command: Display_ctrl_2

Table 8. Display_ctrl_2 - display control command 2 register (address 03h) bit description

| Bit | Symbol | Value | Description |
|--------|---------|-------|--|
| 7 to 3 | - | 00000 | default value |
| 2 to 1 | BL[1:0] | | blink control |
| | | 00[1] | blinking off |
| | | 01 | blinking on, f _{blink} = 0.5 Hz |
| | | 10 | blinking on, f _{blink} = 1 Hz |
| | | 11 | blinking on, f _{blink} = 2 Hz |
| 0 | INV | | inversion mode selection |
| | | 0[1] | line inversion (driving scheme A) |
| | | 1 | frame inversion (driving scheme B) |

[1] Default value.

8.2.3.1 Blinking

The whole display blinks at frequencies selected by the blink control bits BL[1:0], see <u>Table 8</u>. The blink frequencies are derived from the clock frequency. During the blank-out phase of the blinking period, the display is turned off.

If an external clock with frequency $f_{clk(ext)}$ is used, the blinking frequency is determined by Equation 1. For notation, see Section 9.2.

$$f_{blink(eff)} = \frac{2 \times n_{MUX} \times f_{fr} \times f_{blink}}{f_{clk(ext)}}$$
(1)

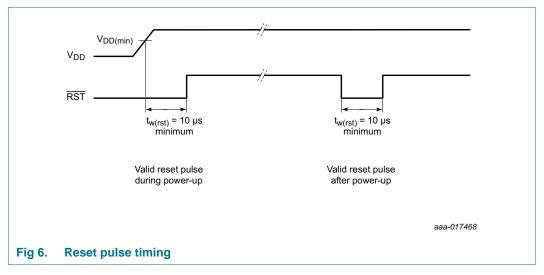
8.2.3.2 Line inversion (driving scheme A) and frame inversion (driving scheme B)

The waveforms used to drive LCD inherently produce a DC voltage across the display cell. The PCA8561 compensates for the DC voltage by inverting the waveforms on alternate frames or alternate lines. The choice of compensation method is determined with the INV bit.

8.3 Starting and resetting the PCA8561

If the internal Power-On Reset (POR) is enabled by connecting pin PORE to V_{DD} , the chip resets automatically when V_{DD} rises above the minimum supply voltage. No further action is required.

If the internal POR is disabled by connecting pin PORE to V_{SS} , the chip must be reset by driving the RST pin to logic 0 for at least 10 μ s, see Figure 6.



Alternatively a software reset can be applied (see Section 8.3.4).

Following a reset, the register 00h has to be rewritten with 0h by the next command byte or the address pointer AP[4:0] has to be set to the required address after a new START procedure.

8.3.1 Power-down mode

After a reset, the PCA8561 remains in power-down mode. In power-down mode the oscillator is switched off and there is no output on pin CLK. The register settings remain unchanged and the bus remains active. To enable the PCA8561, bit DE (command Display_ctrl_1, see Table 7 on page 8) must be set to logic 1.

8.3.2 Power-On Reset (POR)

If pin PORE is connected to V_{DD} , the PCA8561 comprises an internal POR, which puts the device into the following starting conditions:

- All backplane and segment outputs are set to V_{SS}
- The selected drive mode is: 1:4 multiplex with $\frac{1}{3}$ bias
- Blinking is switched off
- The address pointer is cleared (set to logic 0)
- The display and the internal oscillator are disabled
- The display registers are set to logic 0
- The bus interface is initialized

Remark: The internal POR can be disabled by connecting pin PORE to V_{SS} . In this case, the internal registers are not defined and require a hardware reset according to <u>Section 8.3.3</u> or a software reset, see <u>Section 8.3.4</u>.

8.3.3 Hardware reset: RST pin

At power-on the PCA8561 can be reset to the following starting conditions by pulling pin RST low:

- All backplane and segment outputs are set to V_{SS}
- The selected drive mode is: 1:4 multiplex with $\frac{1}{3}$ bias
- Blinking is switched off
- The bus interface is initialized
- The address pointer is cleared (set to logic 0)
- The display and the internal oscillator are disabled
- The display registers are set to logic 0

Remark: The hardware reset overrides the POR see <u>Section 8.3.2</u>.

8.3.4 Command: Software_reset

The internal registers including the display registers and the address pointer (set to logic 0) of the device are reset by the Software_reset command.

Table 9.Software_reset - software reset command register (address 00h) bit descriptionThis register can only be written but not read.

| Bit | Symbol | Value | Description | |
|--------|---------|-------------|----------------|--|
| 7 to 0 | SR[7:0] | | software reset | |
| | | 00000000[1] | no reset | |
| | | 00101100 | software reset | |

[1] Default value.

8.4 Display data register mapping

The example in <u>Table 10</u> and <u>Figure 7</u> illustrates the segment and backplane mapping of the display in relation to the display RAM.

For example, in 1:4 multiplex drive mode, the backplanes are served by signals COM0 to COM3 and the segments are driven by signals SEG0 to SEG17. Contents of addresses 04h to 06h are allocated to the first row (COM0) starting with the LSB driving the leftmost element and moving forward to the right with increasing bit position. If a bit is logic 0, the element is off, if it is logic 1 the element is turned on. All register content is LSB to MSB left to right. Addresses 07h to 09h serve COM1 signals, addresses 0Ah to 0Ch serve COM2 signals, and addresses 0Dh to 0Fh serve COM3 signals.

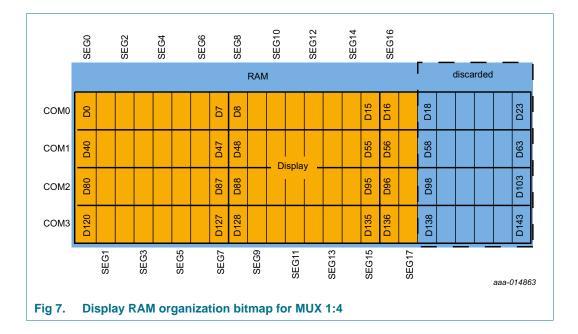
For displays with fewer segments/elements the unused bits are ignored.

| Backplanes ^[1] | Segments | Segments | | | | | | | |
|---------------------------|---------------|----------------|-----------|-------------------------------------|------------|-------------------------------|--|--|--|
| | SEG0 to SE | SEG0 to SEG7 | | SEG15 | SEG16 to | SEG17 | | | |
| | LSB | MSB | LSB | MSB | LSB | MSB | | | |
| 1:4 multiplex dr | ive mode | | | | | | | | |
| COM0 | content of 04 | lh | content o | of 05h | content of | 06h <mark>2</mark> | | | |
| COM1 | content of 07 | 'n | content c | of 08h | content of | 09h <mark>2</mark> | | | |
| COM2 | content of 0A | ٨h | content o | of 0Bh | content of | content of 0Ch ^[2] | | | |
| COM3 | content of OE | content of 0Dh | | content of 0Eh | | content of 0Fh ^[2] | | | |
| 1:3 multiplex dr | ive mode | | | | | | | | |
| COM0 | content of 04 | lh | content o | content of 05h | | 06h <mark>[2]</mark> | | | |
| COM1 | content of 07 | 'n | content o | content of 08h | | content of 09h ^[2] | | | |
| COM2 | content of 0A | ۱h | content c | content of 0Bh | | content of 0Ch ^[2] | | | |
| 1:2 multiplex dr | ive mode | | | | | | | | |
| COM0 | content of 04 | lh | content c | content of 05h | | 06h <mark>2</mark> | | | |
| COM1 | content of 07 | 'n | content o | f 08h content of 09h ^[2] | | | | | |
| static drive mod | le | | | | | | | | |
| COM0 | content of 04 | h | content o | of 05h | content of | 06h <mark>[2]</mark> | | | |

Table 10. Register to segment and backplane mapping

[1] See also <u>Section 9.3.1 on page 23</u>.

[2] Bits [7:2] are ignored.



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9. Possible display configurations

The possible display configurations of the PCA8561 depend on the number of active backplane outputs required. A selection of display configurations is shown in <u>Table 11</u>. All of these configurations can be implemented in the typical systems shown in <u>Figure 9</u> or <u>Figure 10</u>.

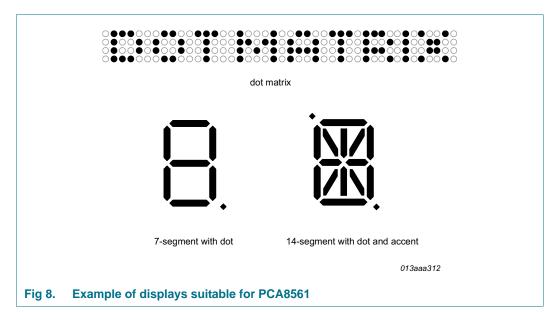


Table 11. Selection of possible display configurations

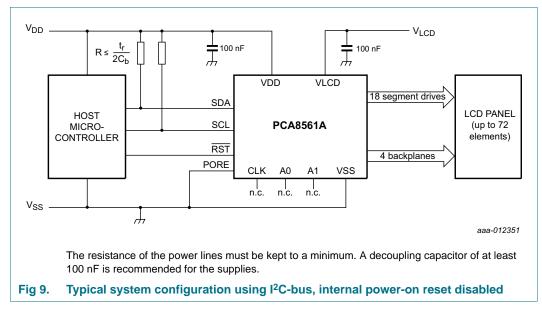
| Number of | | | | | | | |
|------------|-------|--------------------------|-----------------------|------------------|--|--|--|
| Backplanes | Icons | Digits/Characte | Digits/Characters | | | | |
| | | 7-segment ^[1] | segments/ elements | | | | |
| 4 | 72 | 9 | 4 | 72 dots (4 × 18) | | | |
| 3 | 54 | 6 | 3 | 54 dots (3 × 18) | | | |
| 2 | 36 | 4 | 2 | 36 dots (2 × 18) | | | |
| 1 | 18 | 2 | 1 | 18 dots (1 × 18) | | | |

[1] 7 segment display has 8 segments/elements including the decimal point.

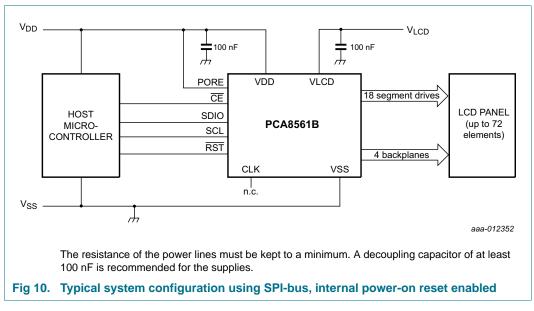
[2] 14 segment display has 16 segments/elements including decimal point and accent dot.

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The host microcontroller manages the 2-line l²C-bus communication channel with the PCA8561. The internal oscillator is used and the internal POR is disabled in the example (Figure 9). The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the reset, the power supplies (V_{DD}, V_{SS}, and V_{LCD}) and the LCD panel chosen for the application.



The host microcontroller manages the 3-line SPI-bus communication channel with the PCA8561. The internal oscillator is enabled and the internal POR is enabled in the example (Figure 10). The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are reset, the power supplies (V_{DD}, V_{SS}, and V_{LCD}) and the LCD panel chosen for the application.

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9.1 LCD bias generator

Fractional LCD biasing voltages are obtained from an internal voltage divider of three impedances connected between V_{LCD} and V_{SS} . These intermediate levels are tapped off at positions of $\frac{1}{3}$ and $\frac{2}{3}$, or $\frac{1}{2}$, depending on the bias mode chosen. To keep current consumption to a minimum, on-chip low-power buffers provide these levels to the display.

9.2 LCD voltage selector

The LCD voltage selector coordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by the Display_ctrl_1 command (see <u>Table 7</u>). The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of V_{LCD} and the resulting discrimination ratios (D) are given in <u>Table 12</u>.

| LCD drive | | | LCD bias | V _{off(RMS)} | V _{on(RMS)} | $D - \frac{V_{on(RMS)}}{V_{on(RMS)}}$ | |
|---------------|------------|--------|---------------|-----------------------|----------------------|---------------------------------------|--|
| mode | Backplanes | Levels | configuration | V _{LCD} | V _{LCD} | $D = \frac{on(RMS)}{V_{off(RMS)}}$ | |
| static | 1 | 2 | static | 0 | 1 | x | |
| 1:2 multiplex | 2 | 3 | 1/2 | 0.354 | 0.791 | 2.236 | |
| 1:2 multiplex | 2 | 4 | 1/3 | 0.333 | 0.745 | 2.236 | |
| 1:3 multiplex | 3 | 4 | 1/3 | 0.333 | 0.638 | 1.915 | |
| 1:4 multiplex | 4 | 4 | 1/3 | 0.333 | 0.577 | 1.732 | |

Table 12. Biasing characteristics

A practical value for V_{LCD} is determined by equating V_{off(RMS)} with a defined LCD threshold voltage (V_{th(off)}), typically when the LCD exhibits approximately 10 % contrast. In the static drive mode, a suitable choice is V_{LCD} > $3V_{th(off)}$.

Multiplex drive modes of 1:3 and 1:4 with $\frac{1}{2}$ bias are possible but the discrimination and hence the contrast ratios are smaller.

Bias is calculated with Equation 2

$$\frac{1}{1+a_{hias}}$$

The values for a_{bias} are:

$$a_{bias} = 1$$
 for $\frac{1}{2}$ bias
 $a_{bias} = 2$ for $\frac{1}{3}$ bias

The RMS on-state voltage (Von(RMS)) for the LCD is calculated with Equation 3:

$$V_{on(RMS)} = V_{LCD} \sqrt{\frac{a_{bias}^2 + 2a_{bias} + n_{MUX}}{n_{MUX} \times (1 + a_{bias})^2}}$$
(3)

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where the values for n_{MUX} are

 $n_{MUX} = 1$ for static drive mode

n_{MUX} = 2 for 1:2 multiplex drive mode

n_{MUX} = 3 for 1:3 multiplex drive mode

n_{MUX} = 4 for 1:4 multiplex drive mode

The RMS off-state voltage (V_{off(RMS)}) for the LCD is calculated with Equation 4:

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a_{bias}^2 - 2a_{bias} + n_{MUX}}{n_{MUX} \times (1 + a_{bias})^2}}$$
(4)

Discrimination is a term which is defined as the ratio of the on and off RMS voltages $(V_{on(RMS)} \text{ to } V_{off(RMS)})$ across a segment. It can be thought of as a measurement of contrast. Discrimination is determined from Equation 5:

$$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{a_{bias}^2 + 2a_{bias} + n_{MUX}}{a_{bias}^2 - 2a_{bias} + n_{MUX}}}$$
(5)

Using Equation 5, the discrimination for an LCD drive mode of 1:3 multiplex with $\frac{1}{2}$ bias is $\sqrt{3} = 1.732$ and the discrimination for an LCD drive mode of 1:4 multiplex with $\frac{1}{2}$ bias is $\frac{\sqrt{21}}{3} = 1.528$.

The advantage of these LCD drive modes is a reduction of the LCD full scale voltage V_{LCD} as follows:

- 1:3 multiplex (1/2 bias): $V_{LCD} = \sqrt{6} \times V_{off(RMS)} = 2.449 V_{off(RMS)}$
- 1:4 multiplex (¹/₂ bias): $V_{LCD} = \left[\frac{(4 \times \sqrt{3})}{3}\right] = 2.309 V_{off(RMS)}$

These compare with $V_{LCD} = 3V_{off(RMS)}$ when $\frac{1}{3}$ bias is used.

V_{LCD} is sometimes referred as the LCD operating voltage.

9.2.1 Electro-optical performance

Suitable values for $V_{on(RMS)}$ and $V_{off(RMS)}$ are dependent on the LCD liquid used. The RMS voltage, at which a pixel is switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at $V_{th(off)}$) and the other at 90 % relative transmission (at $V_{th(on)}$), see Figure 11. For a good contrast performance, the following rules should be followed:

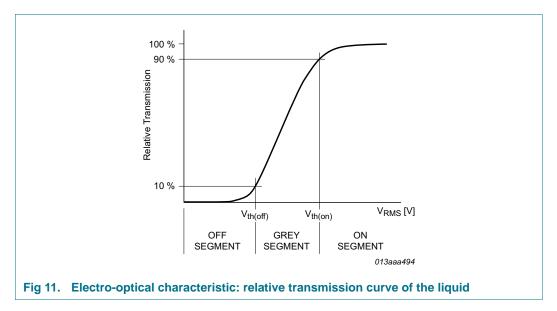
| $V_{on(RMS)} \ge V_{th(on)}$ | (6) |
|--------------------------------|-----|
| $V_{off(RMS)} \le V_{th(off)}$ | (7) |

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 $V_{on(RMS)}$ (see <u>Equation 3</u>) and $V_{off(RMS)}$ (see <u>Equation 5</u>) are properties of the display driver and are affected by the selection of a_{bias} , n_{MUX} , and the V_{LCD} voltage.

 $V_{th(off)}$ and $V_{th(on)}$ are properties of the LCD liquid and can be provided by the module manufacturer. $V_{th(off)}$ is sometimes named $V_{th}.$ $V_{th(on)}$ is sometimes named saturation voltage $V_{sat}.$

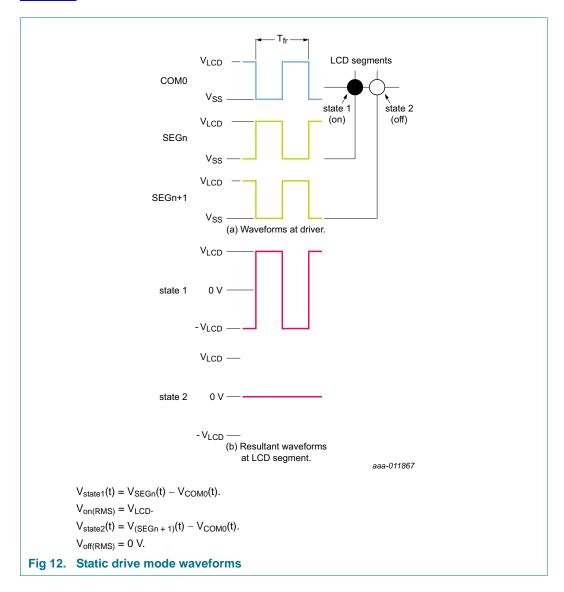
It is important to match the module properties to those of the driver in order to achieve optimum performance.



9.2.2 LCD drive mode waveforms

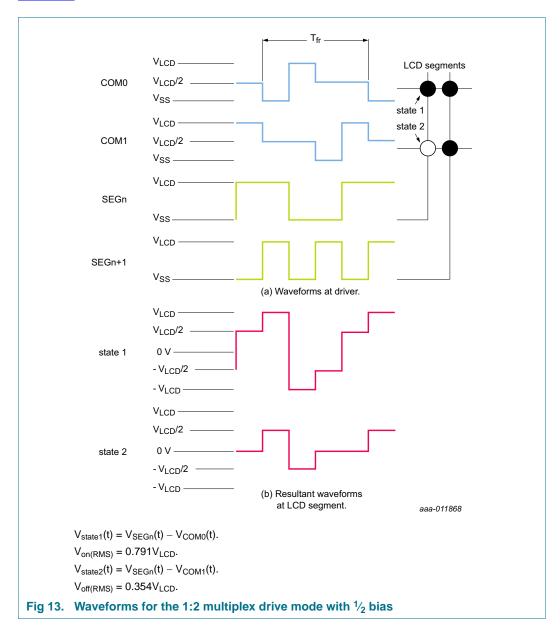
9.2.2.1 Static drive mode

The static LCD drive mode is used when a single backplane is provided in the LCD. The backplane (COMn) and segment (SEGn) drive waveforms for this mode are shown in Figure 12.



9.2.2.2 1:2 Multiplex drive mode

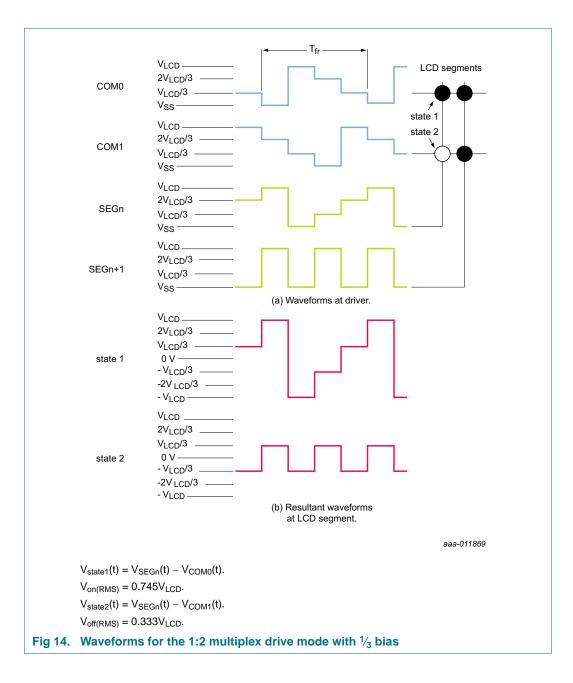
When two backplanes are provided in the LCD, the 1:2 multiplex mode applies. The PCA8561 allows the use of $\frac{1}{2}$ bias or $\frac{1}{3}$ bias in this mode as shown in Figure 13 and Figure 14.



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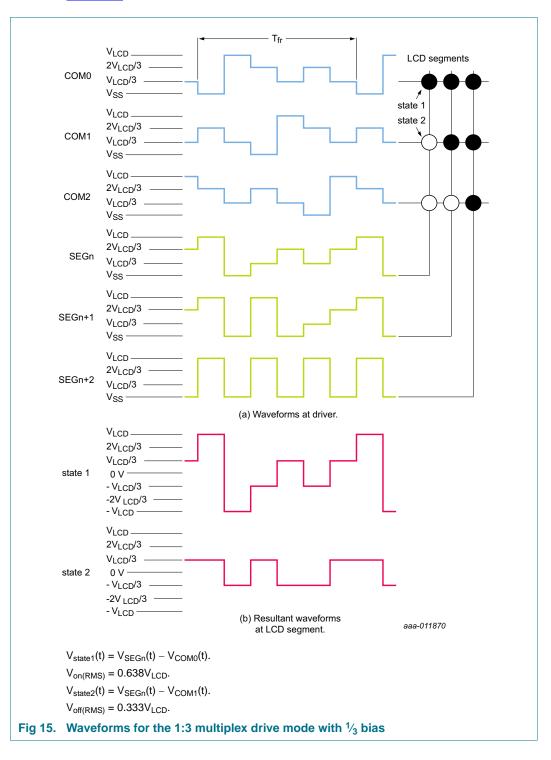
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9.2.2.3 1:3 Multiplex drive mode

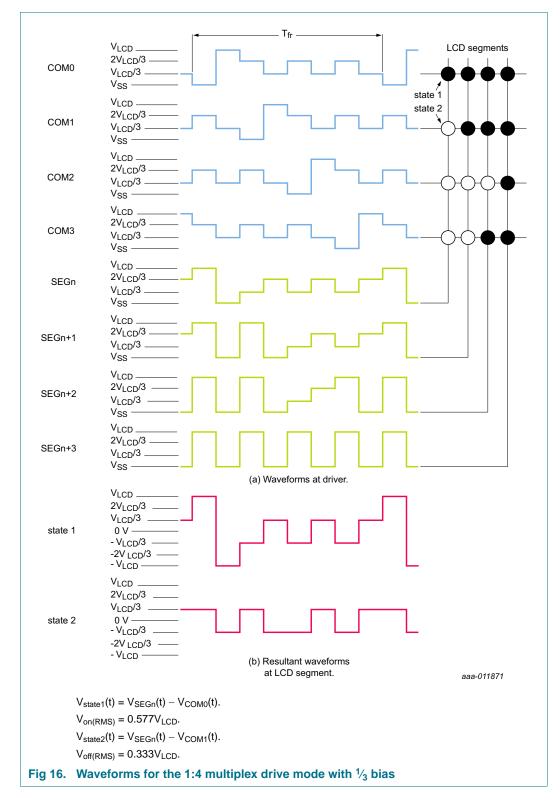
When three backplanes are provided in the LCD, the 1:3 multiplex drive mode applies, as shown in Figure 15.



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9.2.2.4 1:4 Multiplex drive mode

When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies as shown in Figure 16.



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9.3 Backplane and segment outputs

9.3.1 Backplane outputs

The LCD drive section includes four backplane outputs COM0 to COM3, which must be directly connected to the LCD. The backplane output signals are generated in accordance with the selected LCD drive mode. If less than four backplane outputs are required, the unused outputs can be left open-circuit.

- In 1:3 multiplex drive mode, COM3 carries the same signal as COM1, therefore these two outputs can be tied together to give enhanced drive capabilities
- In 1:2 multiplex drive mode, COM0 and COM2, respectively, COM1 and COM3 all carry the same signals and may also be paired to increase the drive capabilities
- In static drive mode, the same signal is carried by all four backplane outputs and they can be connected in parallel for very high drive requirements

9.3.2 Segment outputs

The LCD drive section includes 18 segment outputs SEG0 to SEG17, which must be directly connected to the LCD. The segment output signals are generated in accordance with the multiplexed backplane signals and with data residing in the display registers. When less than 18 segment outputs are required, the unused segment outputs must be left open-circuit.

10. Power Sequencing

10.1 Power-on

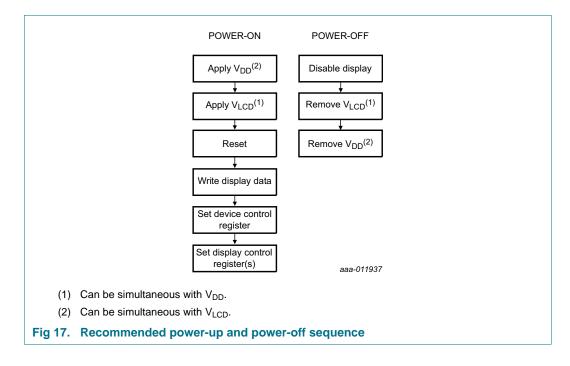
To avoid unwanted artifacts on the display, V_{LCD} must never be asserted before V_{DD} , it is permitted to assert V_{DD} and V_{LCD} at the same time.

10.2 Power-off

Before turning the power to the device off, the display must be disabled by setting bit DE to logic 0. To avoid unwanted artifacts on the display, V_{LCD} must never be connected, while V_{DD} is switched off. It is permitted to switch off V_{DD} and V_{LCD} simultaneously.

10.3 Power sequences

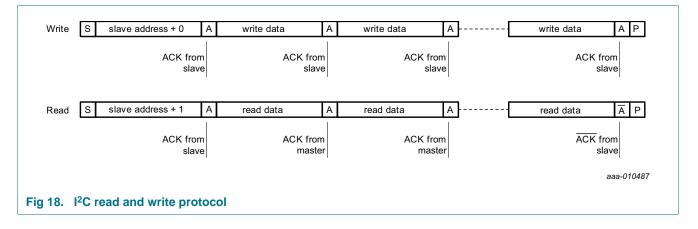
Figure 17 depicts the recommended power-up and power-off sequence.

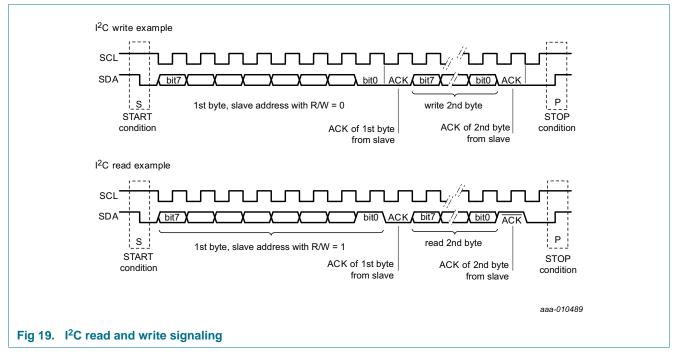


11. Bus interfaces

11.1 I²C-bus interface of the PCA8561A

The I²C-bus is for bidirectional, two-line communication between different ICs. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy. Both data and clock lines remain HIGH when the bus is not busy. The PCA8561 acts as a slave receiver when being written to and as a slave transmitter when being read from.





11.1.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse, as changes in the data line at this time are interpreted as STOP or START conditions.

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11.1.2 START and STOP conditions

A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition - S.

A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition - P (see Figure 19).

11.1.3 Acknowledge

Each byte of 8 bits is followed by an acknowledge cycle. An acknowledge is defined as logic 0. A not-acknowledge is defined as logic 1.

When written to, the slave will generate an acknowledge after the reception of each byte. After the acknowledge, another byte may be transmitted. It is also possible to send a STOP or START condition.

When read from, the master receiver must generate an acknowledge after the reception of each byte. When the master receiver no longer requires bytes to be transmitted, it must generate a not-acknowledge. After the not-acknowledge, either a STOP or START condition must be sent.

Remark: The PCA8561 omits the not-acknowledge. After the last byte read, the end of transmission is indicated by a STOP or START condition from the master.

A detailed description of the I²C-bus specification is given in Ref. 12 "UM10204".

11.1.4 I²C interface protocol

The PCA8561 uses the I^2C interface for data transfer. Interpretation of the data is determined by the interface protocol.

11.1.4.1 Write protocol

After the I²C slave address is transmitted, the PCA8561 requires that the register address pointer is defined. It can take the value 00h to 0Fh. Values outside of that range will result in the transfer being ignored, however the slave will still respond with acknowledge pulses.

After the register address has been transmitted, write data is transmitted. The minimum number of data write bytes is 0 and the maximum number is unlimited. After each write, the address pointer increments by one. After address 0Fh, the address pointer stops incrementing at address 10h.

- I²C START condition
- I²C slave address + write
- start register pointer
- write data
- write data
- :
- write data
- I²C STOP condition; an I²C RE-START condition is also possible.

11.1.4.2 Read protocol

When reading the PCA8561, reading starts at the current position of the address pointer. The address pointer for read data should first be defined by a write sequence.

- I²C START condition
- I²C slave address + write
- start address pointer
- I²C STOP condition; an I²C RE-START condition is also possible.

After setting the address pointer, a read can be executed. After the I²C slave address is transmitted, the PCA8561 will immediately output read data. After each read, the address pointer increments by one. After address 0Fh, the address pointer stops incrementing at 10h.

- I²C START condition
- I²C slave address + read
- read data (master sends acknowledge bit)
- · read data (master sends acknowledge bit)
- :

11.1.4.3 I²C-bus slave address

Device selection depends on the I^2 C-bus slave address. Four different I^2 C-bus slave addresses can be used to address the PCA8561 (see <u>Table 13</u>).

Table 13. I²C slave address byte

| | Slave ad | Slave address | | | | | | |
|-----|----------|---------------|---|---|---|----|----|----------|
| Bit | 7 MSB | 6 | 5 | 4 | 3 | 2 | 1 | 0 LSB |
| | 0 | 1 | 1 | 1 | 0 | A1 | A0 | R/W |

The least significant bit of the slave address byte is bit R/W (see Table 14).

Table 14. R/W-bit description

| R/W | Description |
|-----|-------------|
| 0 | write data |
| 1 | read data |

Bit 1 and bit 2 of the slave address are defined by connecting the input pins A0 and A1 to either V_{SS} (logic 0) or V_{DD} (logic 1). Therefore, four instances of PCA8561 can be distinguished on the same I²C-bus.

11.2 SPI-bus interface of the PCA8561B

Data transfer to the device is made via a 3-line SPI-bus (see <u>Table 15</u>). There is no dedicated output data line. The SPI-bus is initialized whenever the chip enable line pin \overline{CE} is pulled down.

Table 15. Serial interface

| - | Function | Description |
|------|---|---|
| CE | chip enable input ^[1] ; active LOW | when HIGH, the interface is reset |
| SCL | serial clock input | input may be higher than V _{DD} |
| SDIO | serial data input/output | input data are sampled on the rising edge of SCL, output data are valid after the falling edge of SCL |

[1] The chip enable must not be wired permanently LOW.

11.2.1 Data transmission

The chip enable signal is used to identify the transmitted data. Each data transfer is a byte with the Most Significant Bit (MSB) sent first.

The transmission is controlled by the active LOW chip enable signal \overline{CE} . The first byte transmitted is the register address comprising of the address pointer and the R/W bit.

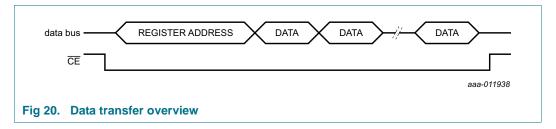


Table 16. Address byte definition

| Bit | Symbol | Value | Description |
|--------|---------|------------|--|
| 7 | R/W | | data read or write selection |
| | | 0 | write data |
| | | 1 | read data |
| 6 to 5 | - | 00 | default value |
| 4 to 0 | AP[4:0] | | pointer to register start address |
| | | 00h to 0Fh | valid range; other addresses are ignored |

After the register address byte, the register contents follows with the address pointer being auto-incremented after every eighth bit sent (see <u>Section 8.1 on page 6</u>).

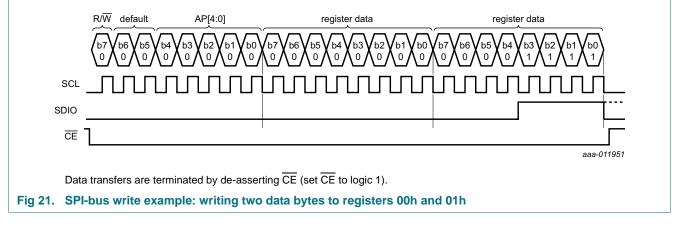
11.2.1.1 Write protocol

After the \overline{CE} is set LOW, the PCA8561 requires that R/W and the register address pointer is defined. It can take the value 00h to 0Fh. Values outside of that range will result in the transfer being ignored.

After the register address has been transmitted, write data is transmitted. The minimum number of data write bytes is 0 and the maximum number is unlimited. After each write, the address pointer increments by one. After address 0Fh, the address pointer stops incrementing at 10h.

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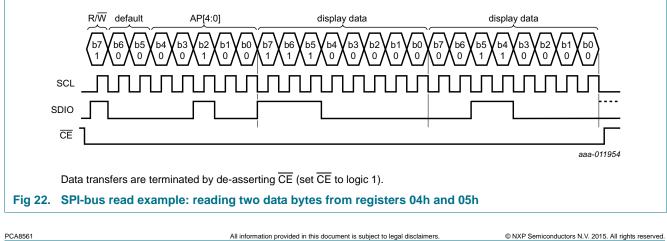
- CE set LOW
- $R/\overline{W} = 0$ and register address
- write data
- write data
- :
- write data
- CE set HIGH



11.2.1.2 Read protocol

When reading the PCA8561, reading starts at the defined position of the address pointer. After setting the address pointer, the read can be executed. After each read, the address pointer increments by one. After address 0Fh, the address pointer stops incrementing at 10h.

- CE set LOW
- R/W = 1 and register address
- read data
- read data
- :
- CE set HIGH

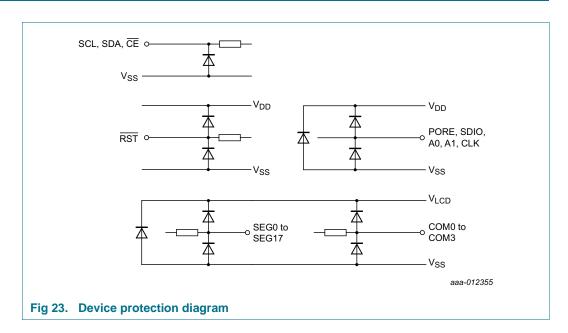


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11.3 EMC detection

The PCA8561 is ruggedized against EMC susceptibility; however it is not possible to cover all cases. To detect if a severe EMC event has occurred, it is possible to check the responsiveness of the device by reading its registers.

12. Internal circuitry



13. Safety notes

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

CAUTION



Static voltages across the liquid crystal display can build up when the LCD supply voltage (V_{LCD}) is on while the IC supply voltage (V_{DD}) is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts, V_{LCD} and V_{DD} must be applied or removed together.

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14. Limiting values

Table 17. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|-------------------------|----------------------|----------|-------|------|
| V _{DD} | supply voltage | | -0.5 | +6.5 | V |
| V _{LCD} | LCD supply voltage | | -0.5 | +6.5 | V |
| VI | input voltage | | -0.5 | +6.5 | V |
| Vo | output voltage | | -0.5 | +6.5 | V |
| l _l | input current | | -10 | +10 | mA |
| lo | output current | | -10 | +10 | mA |
| I _{DD} | supply current | | -50 | +50 | mA |
| I _{DD(LCD)} | LCD supply current | | -50 | +50 | mA |
| I _{SS} | ground supply current | | -50 | +50 | mA |
| P _{tot} | total power dissipation | | - | 100 | mW |
| Po | output power | | - | 100 | mW |
| V _{ESD} | electrostatic discharge | НВМ | 1 | | |
| | voltage | on pins SCL, SDA, CE | - | ±2000 | V |
| | | on all other pins | - | ±3500 | V |
| | | CDM | - | ±2000 | V |
| l _{lu} | latch-up current | <u>[</u>] | <u>-</u> | 200 | mA |
| T _{stg} | storage temperature | <u>ا</u> | -55 | +150 | °C |
| T _{amb} | ambient temperature | operating device | -40 | +105 | °C |

[1] Pass level; Human Body Model (HBM), according to Ref. 7 "JESD22-A114".

[2] Pass level; Charged-Device Model (CDM), according to Ref. 8 "JESD22-C101".

[3] Pass level; latch-up testing according to Ref. 9 "JESD78" at maximum ambient temperature (T_{amb(max)}).

[4] According to the store and transport requirements (see <u>Ref. 13 "UM10569</u>") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

15. Characteristics

Table 18. Electrical characteristics

 V_{DD} = 1.8 V to 5.5 V; V_{SS} = 0 V; V_{LCD} = 1.8 V to 5.5 V; T_{amb} = -40 °C to +105 °C; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------|------------------------------------|---|--------------------|-----|--------------------|------|
| Supplies | | 1 | 1 | I | I | |
| V _{DD} | supply voltage | | 1.8 | - | 5.5 | V |
| V _{LCD} | LCD supply voltage | | 1.8 | - | 5.5 | V |
| I _{DD} | supply current | f _{fr} = 64 Hz; no bus activity | | | | |
| | | V _{DD} = 3.3 V; T _{amb} = 25 °C | - | 0.6 | - | μA |
| | | V _{DD} = 5.5 V; T _{amb} = 105 °C | - | 1.8 | 3.0 | μA |
| I _{DD(LCD)} | LCD supply current | f _{fr} = 64 Hz; no bus activity [1] | | I | I | |
| | | $V_{LCD} = 5.5 V;$ $T_{amb} = 105 °C;$ BOOST = 0; no display load | - | 3.7 | 4.7 | μΑ |
| | | V _{LCD} = 3.3 V; T _{amb} = 25 °C | | | | I |
| | | BOOST = 0; no display load | - | 2.5 | - | μA |
| | | BOOST = 0; display enabled; display load $C_L = 0.72 \text{ nF}$ | - | 3.5 | - | μA |
| | | BOOST = 1; display enabled; display load $C_L = 0.72 \text{ nF}$ | - | 4.5 | - | μA |
| V _{IL} | LOW-level input voltage | | V _{SS} | - | 0.3V _{DD} | V |
| V _{IH} | HIGH-level input voltage | [2] | 0.7V _{DD} | - | V _{DD} | V |
| I _{OL} | LOW-level output current | output sink current; $V_{OL} = 0.4 \text{ V}$; $V_{DD} = 5 \text{ V}$ | | | | |
| | | on pin CLK | 2 | - | - | mA |
| | | on pin SDIO | 2 | - | - | mA |
| | | on pin SDA | 3 | - | - | mA |
| I _{OH} | HIGH-level output current | output source current; on pins SDIO, CLK; $V_{OH} = 4.6 V$; $V_{DD} = 5 V$ | 2 | - | - | mA |
| ۱ _L | leakage current | any input pin except for RST | - | 0 | - | nA |
| | | after ESD event | -500 | - | +500 | nA |
| R _{pu(RST_n)} | pull-up resistance on pin RST_N | | - | 100 | - | kΩ |
| LCD outpu | its (pins SEG0 to SEG17 an | d COM0 to COM3) | | | | |
| ΔVo | output voltage variation | V _{LCD} = 5 V | -100 | - | +100 | mV |
| Ro | output resistance | V _{LCD} = 5 V [3] | - | 1.5 | 3 | kΩ |

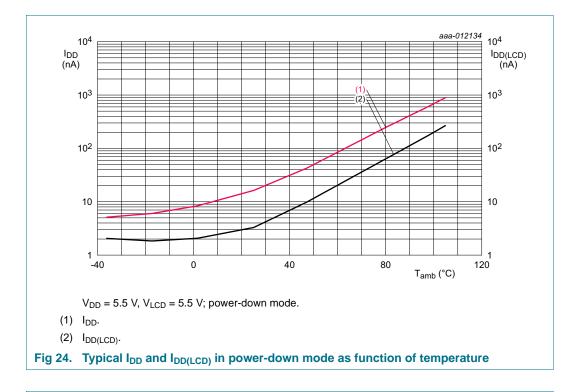
[1] For typical values, also see <u>Figure 24</u> to <u>Figure 26</u>.

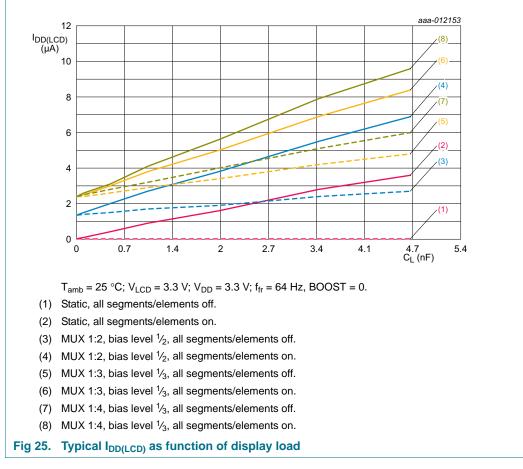
[2] $\ \ I^2C$ pins SCL and SDA have no diode to V_{DD} and may be driven up to 5.5 V.

[3] Outputs measured one at a time.

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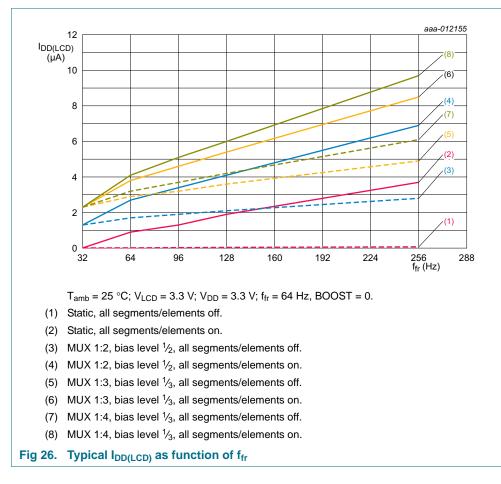


Table 19. Frequency characteristics

 V_{DD} = 1.8 V to 5.5 V; V_{SS} = 0 V; V_{LCD} = 1.8 V to 5.5 V; T_{amb} = -40 °C to +105 °C; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|--------------------------|---|-----|------|------|------|
| f _{fr} 1 | frame frequency | FF[2:0] = 000 | - | 32 | - | Hz |
| | | FF[2:0] = 001 | 42 | 64 | 86 | Hz |
| | | FF[2:0] = 010 | - | 96 | - | Hz |
| | FF[2:0] = 011 | - | 128 | - | Hz | |
| | | FF[2:0] = 100 | - | 160 | - | Hz |
| | | FF[2:0] = 101 | - | 192 | - | Hz |
| | | FF[2:0] = 110 | - | 224 | - | Hz |
| | | FF[2:0] = 111 | - | 256 | - | Hz |
| f _{clk(int)} | internal clock frequency | f _{fr} = 64 Hz, n _{MUX} = 4 [1] | - | 1024 | - | Hz |
| f _{clk(ext)} | external clock frequency | [1] | - | - | 4096 | Hz |
| t _{clk(H)} | HIGH-level clock time | external clock | 60 | - | - | μs |
| t _{clk(L)} | LOW-level clock time | external clock | 60 | - | - | μs |
| t _{w(rst)} | reset pulse width | on pin RST | 10 | - | - | μs |

[1] $f_{clk(int)} = 2 \cdot f_{fr} \cdot n_{MUX}$ or $f_{clk(ext)} = 2 \cdot f_{fr} \cdot n_{MUX}$ respectively (see <u>Table 6</u> and <u>Table 7</u>).

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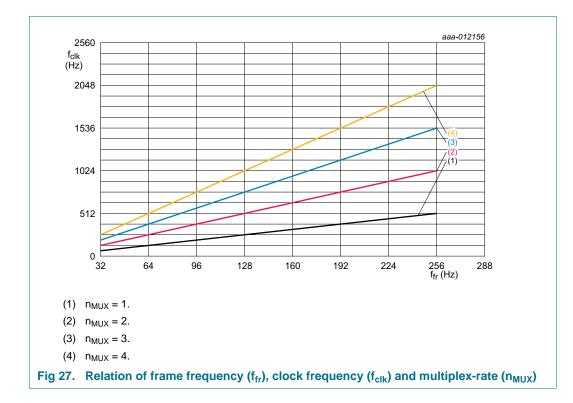


Table 20. I²C-bus characteristics

 $V_{DD} = 1.8 \text{ V}$ to 5.5 V; $V_{SS} = 0 \text{ V}$; $T_{amb} = -40 \text{ °C}$ to +105 °C; unless otherwise specified; all timing values are valid within the operating supply voltage and T_{amb} range and are referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .^[1]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|--|-----------------------------|-----|-----|-----|------|
| Pin SCL | | | | | | I |
| f _{SCL} | SCL clock frequency | | - | - | 400 | kHz |
| t _{LOW} | LOW period of the SCL clock | | 1.3 | - | - | μs |
| t _{HIGH} | HIGH period of the SCL clock | | 0.6 | - | - | μs |
| Pin SDA | | | | | | |
| t _{SU;DAT} | data set-up time | | 100 | - | - | ns |
| t _{HD;DAT} | data hold time | | 0 | - | - | ns |
| Pins SCL | and SDA | | · | | | |
| t _{BUF} | bus free time between a STOP and START condition | | 1.3 | - | - | μs |
| t _{SU;STO} | set-up time for STOP condition | | 0.6 | - | - | μs |
| t _{HD;STA} | hold time (repeated) START condition | | 0.6 | - | - | μs |
| t _{SU;STA} | set-up time for a repeated START condition | | 0.6 | - | - | μs |
| t _r | rise time of both SDA and SCL signals | f _{SCL} = 400 kHz | - | - | 0.3 | μs |
| t _f | fall time of both SDA and SCL signals | | - | - | 0.3 | μs |
| C _b | capacitive load for each bus line | | - | - | 400 | pF |
| t _{w(spike)} | spike pulse width | on the I ² C-bus | - | - | 50 | ns |
| | | | | | I | |

[1] The I²C-bus interface of PCA8561 is 5 V tolerant.

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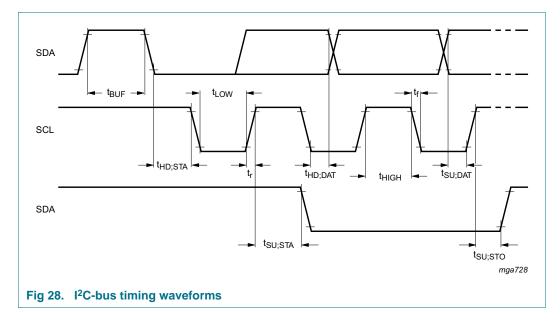


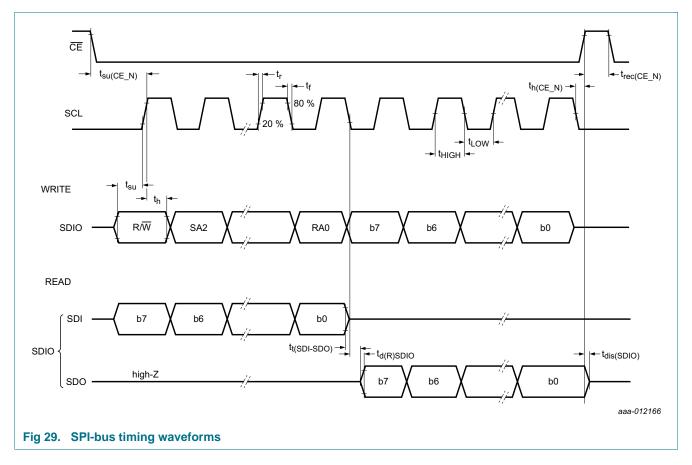
Table 21. SPI-bus characteristics

| V_{DD} = 1.8 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +105 °C; unless otherwise specified; all timing values are valid with | thin the |
|--|----------|
| operating supply voltage and T_{amb} range and are referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DI} | D. |
| | |

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------|---------------------------------|------------------------|-----|-----|-----|------|
| Pin SCL | - | 1 | I | | I | |
| f _{SCL} | SCL clock frequency | | - | - | 5 | MHz |
| t _{LOW} | LOW period of the SCL clock | | 150 | - | - | ns |
| t _{HIGH} | HIGH period of the SCL clock | | 80 | - | - | ns |
| t _r | rise time | | - | - | 100 | ns |
| t _f | fall time | | - | - | 100 | ns |
| Pin CE | | | | | | |
| t _{su(CE_N)} | CE_N set-up time | | 30 | - | - | ns |
| t _{h(CE_N)} | CE_N hold time | | 10 | - | - | ns |
| t _{rec(CE_N)} | CE_N recovery time | | 70 | - | - | ns |
| Pin SDIO | | | | | | · |
| t _{su} | set-up time | write data | 5 | - | - | ns |
| t _h | hold time | write data | 50 | - | - | ns |
| t _{d(R)SDIO} | SDIO read delay time | C _L = 50 pF | - | - | 150 | ns |
| t _{dis(SDIO)} | SDIO disable time | no load | - | - | 50 | ns |
| $t_{t(SDI-SDO)}$ | transition time from SDI to SDO | write to read mode | 0 | - | - | ns |

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16. Application information

16.1 Power-on with a slowly starting power supply

The built-in POR block acts on the rising edge of the V_{DD} supply voltage. It is designed to react to fast slopes. If the system supply starts slowly, it is recommended to initiate a software reset immediately after power-on.

16.2 I²C acknowledge after power-on

If the bus does not show an acknowledge at the first access, the command should be sent a second time.

16.3 Resistors on I/O pins

The pins A0, A1, and PORE comprise internal, latching pull-down devices, which keep these inputs at a low potential when left open. If an input is supposed to be at logic 0 potential, this pin can be either connected to V_{SS} or left open.

In case a pin is supposed to be at logic 1 potential, it must be connected to V_{DD} to avoid any cross-current during power-up. A series resistance between V_{DD} and the associated pin must not exceed 1 k Ω to ensure proper functionality.

17. Test information

17.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

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18. Package outline

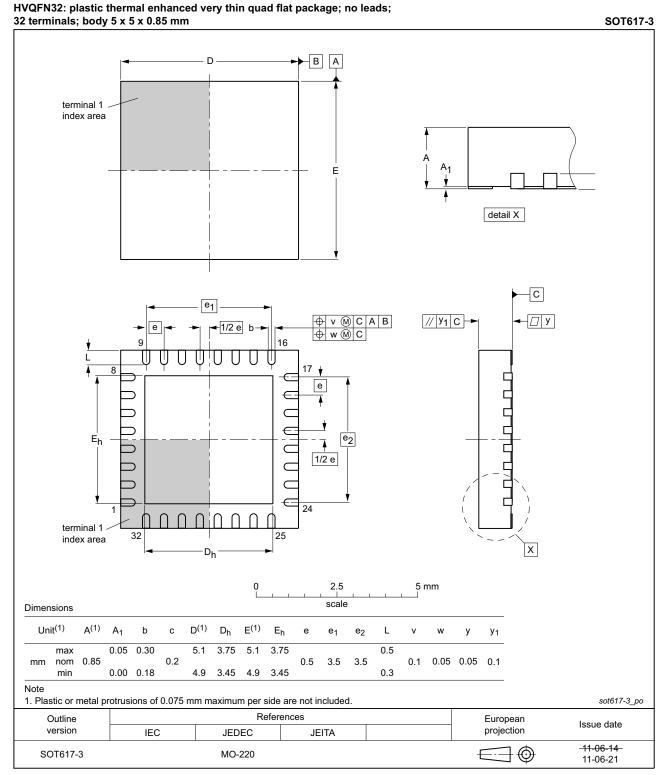


Fig 30. Package outline SOT617-3 (HVQFN32) of PCA8561

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19. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

20. Packing information

20.1 Tape and reel information

For tape and reel packing information, see Ref. 11 "SOT617-3_518" on page 48.

21. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

21.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

21.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages

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- Package placement
- · Inspection and repair
- Lead-free soldering versus SnPb soldering

21.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

21.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 31</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 22 and 23

| Package thickness (mm) | Package reflow temper | rature (°C) |
|------------------------|---------------------------|-------------|
| | Volume (mm ³) | |
| | < 350 | ≥ 350 |
| < 2.5 | 235 | 220 |
| ≥ 2.5 | 220 | 220 |

Table 22. SnPb eutectic process (from J-STD-020D)

Table 23. Lead-free process (from J-STD-020D)

| Package thickness (mm) | Package reflow temp | perature (°C) | |
|------------------------|---------------------------|---------------|--------|
| | Volume (mm ³) | | |
| | < 350 | 350 to 2000 | > 2000 |
| < 1.6 | 260 | 260 | 260 |
| 1.6 to 2.5 | 260 | 250 | 245 |
| > 2.5 | 250 | 245 | 245 |

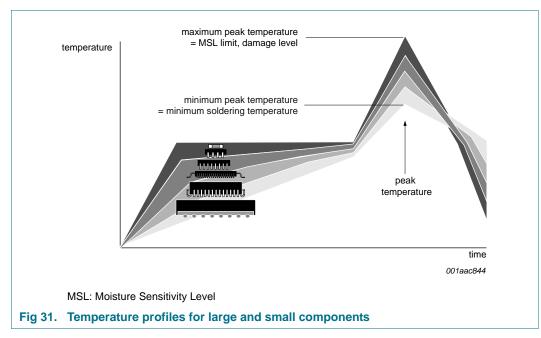
Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 31.

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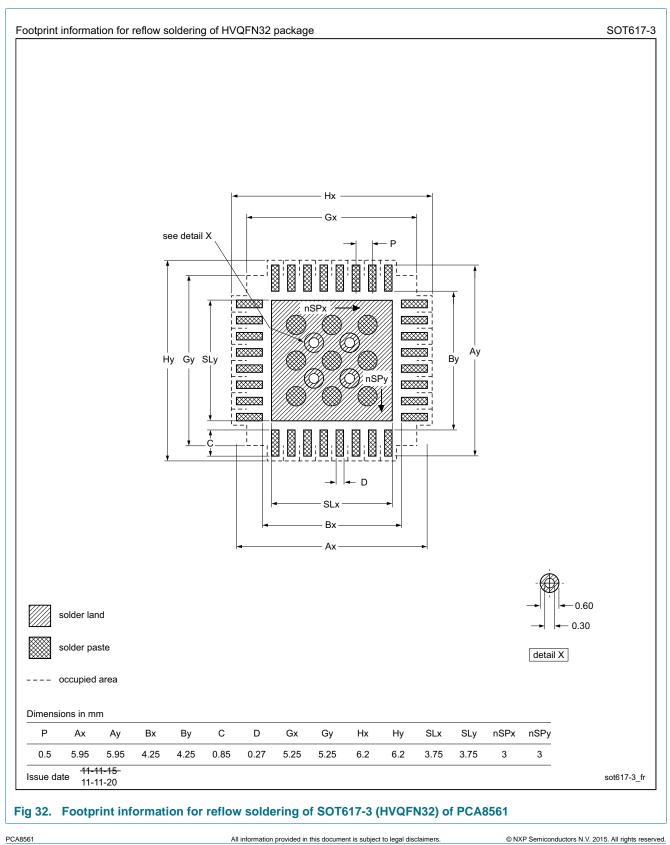
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For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.

Automotive 18 × 4 LCD segment driver

22. Footprint information



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| | | | Selection of LCD segment drivers | lueu | driv | ers | | | | | _ | | | | | |
|------------|----------|---------------------------|----------------------------------|-------|------|-----|---|---------------------|----------------------|--------------------------|--------------------------------|-------------------------------------|-----------------------|------------------------|----------|--------------|
| Type name | Nun 7 | Number of elements at MUX | of elen | nents | at M | | • | V _{DD} (V) | V _{LCD} (V) | f _{fr} (Hz) | V _{LCD} (V) charge | V _{LCD} (V) temperature | T _{amb} (∘C) | Interface | Package | AEC- Q100 |
| | - | <u>.</u> | <u>.</u> | - | | 0 | | | | | pump | compensat. | | | | |
| PCA8553DTT | 40 | 80 | 120 | 160 | | | | 1.8 to 5.5 | 1.8 to 5.5 | 32 to 256 ^[1] | z | z | -40 to 105 | I ² C / SPI | TSSOP56 | ≻ |
| PCA8546ATT | ı | | ı | 176 | | | ı | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | z | z | -40 to 95 | I ² C | TSSOP56 | ≻ |
| PCA8546BTT | | | | 176 | | | | 1.8 to 5.5 | 2.5 to 9 | 60 to 300[1] | z | z | -40 to 95 | SPI | TSSOP56 | ≻ |
| PCA8547AHT | 44 | 88 | | 176 | | | | 1.8 to 5.5 | 2.5 to 9 | 60 to 300[1] | ~ | × | -40 to 95 | I ² C | TQFP64 | ≻ |
| PCA8547BHT | 44 | 88 | | 176 | | | | 1.8 to 5.5 | 2.5 to 9 | 60 to 300[1] | ≻ | × | -40 to 95 | SPI | TQFP64 | ≻ |
| PCF85134HL | 60 | 120 | 180 | 240 | | | ı | 1.8 to 5.5 | 2.5 to 6.5 | 82 | z | z | -40 to 85 | I ² C | LQFP80 | z |
| PCA85134H | 60 | 120 | 180 | 240 | | , | , | 1.8 to 5.5 | 2.5 to 8 | 82 | z | z | -40 to 95 | I ² C | LQFP80 | ≻ |
| PCA8543AHL | 60 | 120 | | 240 | | | | 2.5 to 5.5 | 2.5 to 9 | 60 to 300[1] | ≻ | × | -40 to 105 | I ² C | LQFP80 | ≻ |
| PCF8545ATT | | | | 176 | 252 | 320 | , | 1.8 to 5.5 | 2.5 to 5.5 | 60 to 300[1] | z | z | -40 to 85 | I ² C | TSSOP56 | z |
| PCF8545BTT | | | | 176 | 252 | 320 | , | 1.8 to 5.5 | 2.5 to 5.5 | 60 to 300[1] | z | z | -40 to 85 | SPI | TSSOP56 | z |
| PCF8536AT | ı | | ı | 176 | 252 | 320 | ı | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | z | z | -40 to 85 | I ² C | TSSOP56 | z |
| PCF8536BT | ı | | ı | 176 | 252 | 320 | ı | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | z | z | -40 to 85 | SPI | TSSOP56 | z |
| PCA8536AT | ı | | ı | 176 | 252 | 320 | ı | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | z | z | -40 to 95 | I ² C | TSSOP56 | ≻ |
| PCA8536BT | , | 1 | | 176 | 252 | 320 | | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | z | z | -40 to 95 | SPI | TSSOP56 | ≻ |
| PCF8537AH | 44 | 88 | | 176 | 276 | 352 | , | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | ≻ | × | -40 to 85 | I ² C | TQFP64 | z |
| PCF8537BH | 44 | 88 | ı | 176 | 276 | 352 | | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | × | × | -40 to 85 | SPI | TQFP64 | z |
| PCA8537AH | 44 | 88 | ı | 176 | 276 | 352 | | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | × | 7 | -40 to 95 | I ² C | TQFP64 | ≻ |
| PCA8537BH | 44 | 88 | ı | 176 | 276 | 352 | | 1.8 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | × | 7 | -40 to 95 | SPI | TQFP64 | ≻ |
| PCA9620H | 60 | 120 | ı | 240 | 320 | 480 | | 2.5 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | × | 7 | -40 to 105 | I ² C | LQFP80 | ≻ |
| PCA9620U | 60 | 120 | ı | 240 | 320 | 480 | | 2.5 to 5.5 | 2.5 to 9 | 60 to 300 ^[1] | × | 7 | -40 to 105 | I ² C | Bare die | ≻ |
| PCF8576DU | 40 | 80 | 120 | 160 | , | , | | 1.8 to 5.5 | 2.5 to 6.5 | 77 | z | z | -40 to 85 | I ² C | Bare die | z |
| PCF8576EUG | 40 | 80 | 120 | 160 | ı | ı | ı | 1.8 to 5.5 | 2.5 to 6.5 | 77 | z | z | –40 to 85 | I ² C | Bare die | z |
| PCA8576FUG | 40 | 80 | 120 | 160 | | | | 1.8 to 5.5 | 2.5 to 8 | 200 | z | z | -40 to 105 | I ² C | Bare die | ≻ |
| PCF85133U | C a | 1 60 | 070 | | | | | | | | | | 1 | 1 | : | |
| | 2 | 201 | Z40 | 320 | , | ı | ı | C.C 01 8. I | C.0 01 C.Z | 82, 110 <u>1</u> | z | z | -40 to 85 | I ² C | Bare die | z |

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PCA8561 Automotive 18 × 4 LCD segment driver

^{23.} Appendix

| Type name | Nun | Number of elements at MUX | of elen | nents | at MI | ň | | V _{DD} (V) | V _{LCD} (V) f _{fr} (Hz) | f _{fr} (Hz) | V _{LCD} (V) V _{LCD} (V) | V _{LCD} (V) | T _{amb} (°C) Interface Package | Interface | Package | AEC- |
|--|-------------------|---------------------------|---------|-------|-------------|---|-----|------------------------|---|-----------------------------|---|---------------------------|---|------------------------|----------|------|
| | 1:1 | 1:1 1:2 1:3 1:4 1:6 1:8 | 1:3 | 1:4 | 1:6 | | 1:9 | | | | charge pump | temperature compensat. | | | | Q100 |
| PCA85233UG | 80 | 160 | 160 240 | 320 | ı | 1 | ı | 1.8 to 5.5 2.5 to 8 | 2.5 to 8 | 150, 220 <mark>[2]</mark> | z | z | -40 to 105 l ² C | l ² C | Bare die | ≻ |
| PCF85132U | 160 | 160 320 480 | 480 | 640 | ı | 1 | ı | 1.8 to 5.5 1.8 to 8 | 1.8 to 8 | 60 to 90 <mark>[1]</mark> | z | z | -40 to 85 | l²C | Bare die | z |
| PCA8530DUG | 102 | 102 204 | 1 | 408 | ı | 1 | ı | 2.5 to 5.5 4 to 12 | 4 to 12 | 45 to 300[1] | ≻ | × | -40 to 105 I ² C / SPI | l ² C / SPI | Bare die | ≻ |
| PCA85132U | 160 | 160 320 480 640 | 480 | 640 | ı | 1 | ı | 1.8 to 5.5 1.8 to 8 | 1.8 to 8 | 60 to 90 <mark>[1]</mark> | z | z | -40 to 95 | I ² C | Bare die | ≻ |
| PCA85232U | 160 | 160 320 480 640 | 480 | 640 | ı | 1 | ı | 1.8 to 5.5 1.8 to 8 | 1.8 to 8 | 117 to 176 ^[1] N | z | z | -40 to 95 | I ² C | Bare die | ≻ |
| PCF8538UG | 102 | 102 204 | , | 408 | 408 612 816 | | 918 | 918 2.5 to 5.5 4 to 12 | 4 to 12 | 45 to 300[1] | ≻ | × | -40 to 85 | l ² C / SPI | Bare die | z |
| PCA8538UG | 102 | 102 204 | 1 | 408 | 408 612 816 | | 918 | 918 2.5 to 5.5 4 to 12 | 4 to 12 | 45 to 300[1] | ≻ | × | -40 to 105 I ² C / SPI | l ² C / SPI | Bare die | ≻ |
| [1] Software programmable. [2] Hardware selectable. | gramm: ectable | able. | | | | | | | | | | | | | | |

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|-----|----------------|
| | Connection |

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24. Abbreviations

| Table 25. Abbre | viations |
|------------------|-------------------------------|
| Acronym | Description |
| CDM | Charged-Device Model |
| DC | Direct Current |
| EMC | ElectroMagnetic Compatibility |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| I ² C | Inter-Integrated Circuit bus |
| IC | Integrated Circuit |
| LCD | Liquid Crystal Display |
| LSB | Least Significant Bit |
| MSB | Most Significant Bit |
| MSL | Moisture Sensitivity Level |
| MUX | Multiplexer |
| РСВ | Printed-Circuit Board |
| POR | Power-On Reset |
| RC | Resistance-Capacitance |
| RMS | Root Mean Square |
| SCL | Serial CLock line |
| SDA | Serial DAta line |
| SMD | Surface-Mount Device |
| SPI | Serial Peripheral Interface |

25. References

- [1] AN10365 Surface mount reflow soldering description
- [2] AN10853 ESD and EMC sensitivity of IC
- [3] AN11267 EMC and system level ESD design guidelines for LCD drivers
- [4] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [5] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [6] IPC/JEDEC J-STD-020D Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [7] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [8] JESD22-C101 Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [9] JESD78 IC Latch-Up Test
- [10] JESD625-A Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [11] SOT617-3_518 HVQFN32; Reel dry pack; SMD, 13", packing information
- [12] UM10204 I²C-bus specification and user manual
- [13] UM10569 Store and transport requirements

26. Revision history

Table 26. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--------------------------------|----------------------|---------------|-------------|
| PCA8561 v.4 | 20150327 | Product data sheet | - | PCA8561 v.3 |
| Modifications: | Fixed typo | | | |
| | Added Figure | <u>6</u> | | |
| PCA8561 v.3 | 20150216 | Product data sheet | - | PCA8561 v.2 |
| PCA8561 v.2 | 20141203 | Objective data sheet | - | PCA8561 v.1 |
| PCA8561 v.1 | 20140909 | Objective data sheet | - | - |

27. Legal information

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| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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